

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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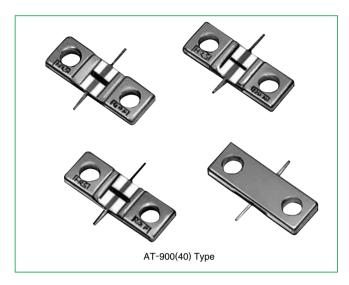






Stripline Mounting Fixed Attenuators (DC to 8 GHz)

AT-900 Series



■Features

1.Frequency Range from DC to 8 GHz

Although these attenuators are of the surface mount type, they offer superior high frequency characteristics from DC to 8 GHz.

2. Abundant Variations of Attenuators

Attenuation amounts are available in 11 types from 0 to 10 dB in 1 dB steps.

■Product Specifications

Ratings	Frequency Range (Note) Characteristic impedance Maximum Input Power (Note)	DC to 8.0 GHz 50 ohms 1 W	Operating temperature range Operating relative humidity	-10°C to +65°C 95% Max.
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Note: The frequency range and the maximum input power will differ depending on the products.

Item	Standard	Conditions		
1.Vibration	No electrical discontinuity of 1 μ s or more	Frequency of 10 to 2000 Hz, overall amplitude of 1.52 mm, acceleration of 98 m/s² for 2 hours in each of 3 directions		
2.Shock	No damage, cracks, or parts dislocation	Acceleration of 490 m/s², sine half-wave waveform, 3 cycles in each of the 3 axis		
3.Temperature cycle	No damage, cracks, or parts dislocation	Temperature: $-55^{\circ}\text{C} \rightarrow +15^{\circ}\text{C}$ to $+35^{\circ}\text{C} \rightarrow +85^{\circ}\text{C} \rightarrow +15^{\circ}\text{C}$ to $+35^{\circ}\text{C}$ Time: $30 \rightarrow 15$ max. $\rightarrow 30 \rightarrow 15$ max. (Minutes) 5 cycles		

The test method conforms to MIL-STD-202.

■Materials

Part	Material	Finish	
Connector Body	Brass	Nickel plating	
Attenuation element	Metal film		
Tabs	Copper	Solder plating	

■Ordering Information

$$\frac{AT}{\bullet} - \frac{9}{@} \frac{01}{@} \frac{(40)}{@}$$

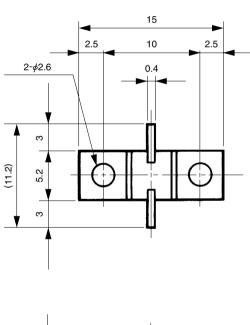
AT: Indicates a fixed attenuator	Attenuation			
	01 : 1dB			
	06 : 6dB			
2 Indicates the Series Name: AT-900 Series	00-(0) : 0dB (Through)			
	00-(1.5): 1.5dB			
	4 (40): RoHS Compliant			

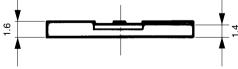


■Specifications

Model No.	Attenuation (dB)		V.S.W.R. (Max)	Power	Surface Temperature at Maximum Load	Weight	RoHS
	DC~4GHz	4∼8GHz	DC~8GHz	(W)	(°C Max)	(g)	
AT-900-(0)(40)	0 +0.5	0 +0.7	1.35	1	+85	1	
AT-901(40)	1±0.5	1±0.7	1.35	1	+85	1	
AT-902(40)	2±0.5	2±0.7	1.35	1	+85	1	
AT-903(40)	3±0.5	3±0.7	1.35	1	+85	1	
AT-904(40)	4±0.5	4±0.7	1.35	1	+85	1	
AT-905(40)	5±0.5	5±0.7	1.35	1	+85	1	YES
AT-906(40)	6±0.5	6±0.7	1.35	1	+85	1	
AT-907(40)	7±0.5	7±0.7	1.35	1	+85	1	
AT-908(40)	8±0.5	8±0.7	1.35	1	+85	1	
AT-909(40)	9±0.5	9±0.7	1.35	1	+85	1	
AT-910(40)	10±0.5	10±0.7	1.35	1	+85	1	

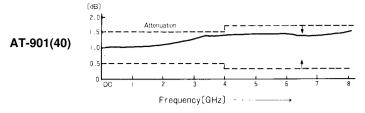
■External Dimensions

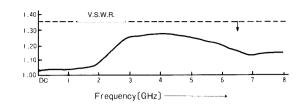


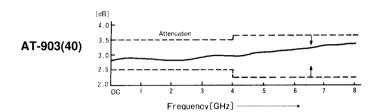


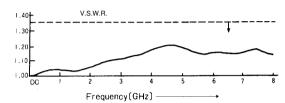
AT-900 Type

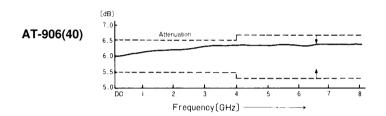
■Typical Data

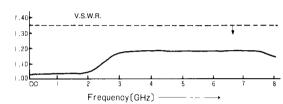


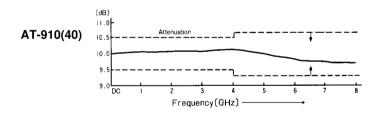


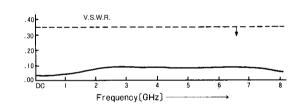






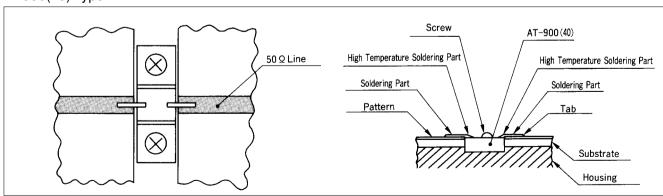






■Mounting Method

AT-900(40) Type



- •Make the AT-900(40) tab height from the housing and the thickness of the microstrip board the same amount.
- ●The tabs are attached with high temperature solder (having a melting point of 280°C). The soldering temperature to the microstrip board must be less than this.